

HT1611/HT1611C Timer with Dialer Interface

Patent Number: 84545 (R.O.C.) Patent Pending: 08/214, 079 (U.S.A.)

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Features

- Operating voltage: 1.2V~1.7V
 Low operating current: 3μA (typ.)
- Dialing number and conversation time display
- Conversation timer (59 mins and 59 secs max.)
- 8 or 10-digit LCD display driver, 3V, 1/2 bias, 1/3 duty

Applications

- Timers, clocks, watches
- · LCD display drivers

General Description

The HT1611/HT1611C is a CMOS chip designed for dialer interfaces driving 8 or 10-digit LCDs. Various functions, such as real time clock, dialing number and conversation time display are provided.

The real time is displayed by default. When answering a telephone call, the timer is activated to tell users how long the conversation has taken. After the telephone is hung up, the total conversation time is shown for about 5

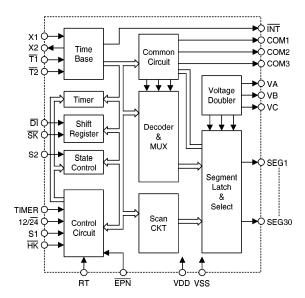
(8-digit hand-held calculator LCD used for 8-digit applications)

- Real time clock with stopwatch
- · Built-in dialer interface
- 12-hour or 24-hour format
- Two-button sequential operation for real time clock setting
- Uses 32768Hz crystal
- Telephone display interface
- Instrument display

seconds and then the real time is displayed again. When making a phone call, the HT1611/HT1611C receives the dialing data from the dialer and displays the phone number from left to right on the LCD. However, if there is no dialing action within 10 seconds, it restarts the timer again. By adding a TIMER key, the HT1611/HT1611C can provide a stopwatch function and timer reset/hold functions (for details, refer to the functional description).

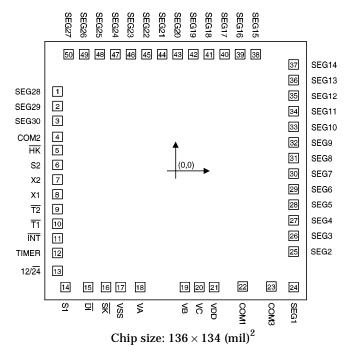


Block Diagram



Pad Assignment

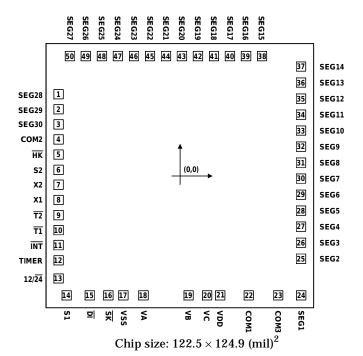
HT1611



^{*} The IC substrate should be connected to VDD in the PCB layout artwork.



HT1611C



* The IC substrate should be connected to VDD in the PCB layout artwork.

Pad Coordinates

HT1611 Unit: mil

Pad No.	X	Y	Pad No.	X	Y	Pad No.	X	Y
1	-61.92	41.65	18	-18.66	-60.80	35	61.63	39.46
2	-61.92	33.98	19	4.72	-60.80	36	61.63	47.60
3	-61.92	26.30	20	12.36	-60.80	37	61.63	55.79
4	-61.92	17.85	21	20.00	-60.80	38	41.78	61.14
5	-61.92	10.95	22	34.98	-60.46	39	33.62	61.14
6	-61.92	3.17	23	50.02	-60.46	40	25.46	61.14
7	-61.92	-4.53	24	61.67	-60.80	41	17.30	61.14
8	-61.92	-12.22	25	61.63	-42.18	42	9.14	61.14
9	-61.92	-19.96	26	61.63	-33.98	43	0.98	61.14
10	-61.92	-27.60	27	61.63	-25.82	44	-7.18	61.14
11	-61.92	-35.26	28	61.63	-17.66	45	-15.34	61.14
12	-61.92	-42.95	29	61.63	-9.50	46	-23.50	61.14
13	-61.92	-52.26	38	61.63	-1.34	47	-31.66	61.14
14	-57.80	-60.80	39	61.63	6.80	48	-39.82	61.14
15	-45.90	-60.80	31	61.63	14.98	49	-47.98	61.14
16	-36.50	-60.80	32	61.63	23.14	50	-56.14	61.14
17	-28.86	-60.80	33	61.63	31.30			



HT1611C Unit: mil

Pad No.	X	Y	Pad No.	X	Y	Pad No.	X	Y
1	-55.73	37.50	18	-16.79	-54.72	35	55.46	35.51
2	-55.73	30.58	19	3.90	-54.72	36	55.46	42.86
3	-55.73	23.66	20	12.43	-54.72	37	55.46	50.20
4	-55.73	16.77	21	18.40	-54.72	38	37.60	55.02
5	-55.73	9.85	22	31.48	-54.72	39	30.26	55.02
6	-55.73	2.85	23	45.02	-54.72	40	22.91	55.02
7	-55.73	-4.07	24	55.50	-54.72	41	15.57	55.02
8	-55.73	-11.00	25	55.46	-37.96	42	8.22	55.02
9	-55.73	-17.96	26	55.46	-30.58	43	0.88	55.02
10	-55.73	-24.84	27	55.46	-23.24	44	-6.46	55.02
11	-55.73	-31.73	28	55.46	-15.89	45	-13.81	55.02
12	-55.73	-38.65	29	55.46	-8.55	46	-21.15	55.02
13	-55.73	-47.03	30	55.46	-1.21	47	-28.50	55.02
14	-52.02	-54.72	31	55.46	6.14	48	-35.84	55.02
15	-41.35	-54.72	32	55.46	13.48	49	-43.18	55.02
16	-32.86	-54.72	33	55.46	20.83	50	-50.53	55.02
17	-25.97	-54.72	34	55.46	28.17			

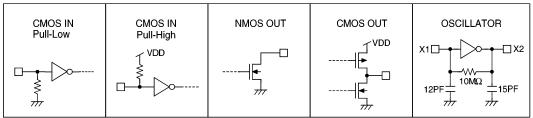
Pad Description

Pad Name	I/O	Internal Connection	Description		
SEG1~SEG30	0	CMOS OUT	LCD segment signal output pads		
COM1~COM3	0	CMOS OUT	LCD common signal output pads		
П К	I	CMOS IN Pull-high	Hook switch detector input Active low		
S2	I	CMOS IN Pull-low	Clock adjusting switch Active high		
X2	0	OSCILLATOR	32768Hz crystal oscillator output		
X1	I	OSCILLATOR	32768Hz crystal oscillator input		
T2	I	CMOS IN Pull-high	Test pad (connected to VSS for production test)		
T1	I	CMOS IN Pull-high	Test pad (connected to VSS for production test)		
ĪNT	О	NMOS OUT	Interrupt output, 2Hz (default) or 16Hz (by mask option)		
TIMER	I	CMOS IN Pull-low	Timer reset and start/hold toggle control input pad		
12/24	I	CMOS IN Pull-low	12-hour or 24-hour format option pad, connected to VDD fo 12-hour format		



Pad Name	I/O	Internal Connection	Description	
S1	I	CMOS IN Pull-low	Clock setting switch Active high	
DI	Ι	CMOS IN Pull-high	Serial data input pad (connected to the dialer) Data should be valid at the falling edge of SK	
SK	Ι	CMOS IN Pull-high	Clock input pad (connected to the dialer)	
VA	0	CMOS OUT	Voltage doubler, connected to the external capacitor	
VB	О	CMOS OUT	Voltage doubler, connected to the external capacitor	
VC	О	CMOS OUT	Voltage doubler, connected to the external capacitor	
VDD	I	_	Positive power supply	
VSS	I	_	Negative power supply (GND)	

Approximate internal connection circuit



Absolute Maximum Ratings

Supply Voltage0.3V to 5V	Storage Temperature50°C to 125°C
Input Voltage V _{SS} -0.3 to V _{DD} +0.3	Operating Temperature20°C to 75°C

Note: These are stress ratings only. Stresses exceeding the range specified under "Absolute Maximum Ratings" may cause substantial damage to the device. Functional operation of this device at other conditions beyond those listed in the specification is not implied and prolonged exposure to extreme conditions may affect device reliability.



Electrical Characteristics

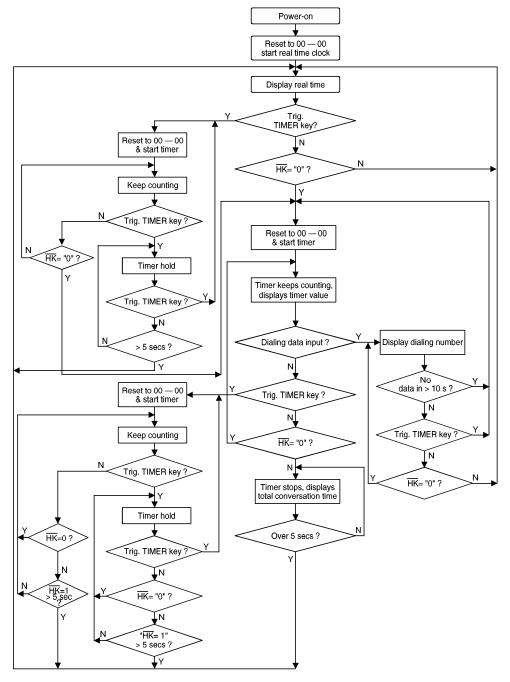
 f_{OSC} =32768Hz, Ta=25°C

Ch al	Danamatan	Test	N/:	Т	NG	Unit	
Symbol	Parameter	V _{DD} Conditions		Min.	Тур.		Max.
V_{DD}	Operating Voltage	_	_	1.2	1.5	1.7	V
V _{IL}	Input Low Voltage	1.2V~17V	_	V _{SS}	_	0.2V _{DD}	V
V _{IH}	Input High Voltage	1.2V~17.V	_	$0.8V_{\mathrm{DD}}$		V_{DD}	V
I _{STB}	Standby Current	1.5V	VHK=Floating (or V _{DD})	_	0.1	1	μΑ
I_{DD}	Operating Current	1.5V	No load	_	3	10	μΑ
I _{OL}	Output Sink Current of INT	1.5V	V _O =0.3V	500	1000	_	μΑ
TA	Data Setup Time	1.5V	_	1	_	_	μs
T _B	Data Hold On Time	1.5V	_	2	_	_	μs
T _C	Inter Digit Time	1.5V	_	5	_	_	μs
T_{DB}	Debounce Time (HK, S1, S2, TIMER)	1.5V	_	_	31.25	_	ms
R _{HI}	Pull-high Resistance (HK, DI, SK)	1.5V	V _{IN} =0V	_	1	_	ΜΩ
R_{LO}	Pull-low Resistance (TIMER, S1, S2, 12/24)	1.5V	V _{TIMER} =1.5V	_	5	_	ΜΩ
fosc	System Frequency	1.5V	Crystal=32768Hz	_	32768	_	Hz



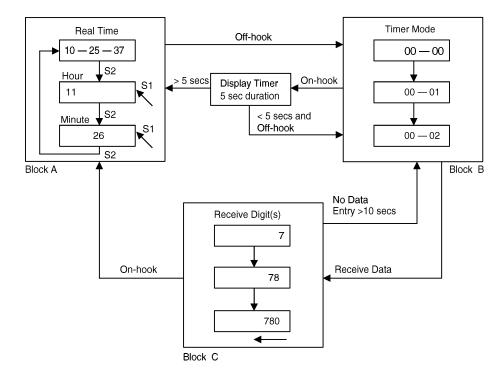
Functional Description

Operational flow chart





On-hook & off-hook



Notes: Block A shows the switches S1 and S2 that are used for setting and selecting.

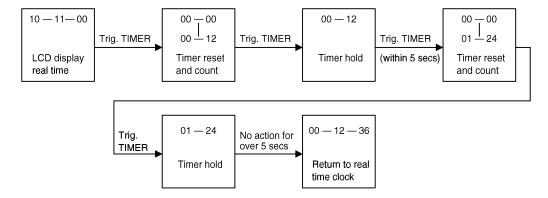
Block B illustrates a timer mode when Off-Hook; timer resets and starts to count the conversation time.

In Block C, the dialing data is received and displayed on the LCD from left to right after Off-Hook. When the entry interval is over 10 seconds, it resets the timer and starts to count.

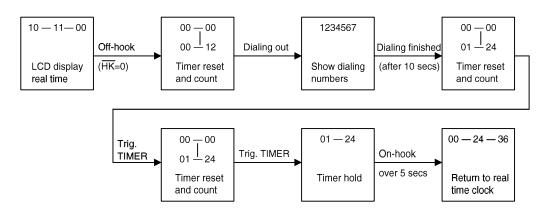


TIMER key function

The TIMER key is used to start/stop the timer (toggle). In real time mode, it can perform a stopwatch function.



In the conversation timer mode, it can reset or hold the timer.





Data & Timing

• For telephone application

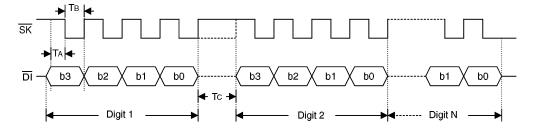
The HT1611/HT1611C is designed to display telephone numbers derived from the HT93XXX series telephone dialers. The corresponding data is illustrated in the following table.

tubic.								
Key-In]	Data	Display					
Key-III	b3 b2 b1 b0				b0			
Blank	0	0	0	0	Blank			
1	0	0	0	1	ı			
2	0	0	1	0	2			
3	0	0	1	1	3			
4	0	1	0	0	ч			
5	0	1	0	1	s			
6	0	1	1	0	6			
7	0	1	1	1	٦			
8	1	0	0	0	8			
9	1	0	0	1	9			
0	1	0	1	0	0			
*	1	1	0	1	_			
#	1	1	0	0				
F	1	0	1	1	F			
P	1	1	1	0	Р			
	1	1	1	1	_			

• For instrument or μC application

The HT1611/HT1611C is also capable of displaying BCD data generated from instrument or a μC system. The corresponding data and timing is shown in the Data latch timing. Before the data is transmitted to the HT1611/HT1611C, the \overline{HK} pin should be pulled-low or continuously kept low. The HT1611 is then ready to receive the data. At the falling edge of the clock the data is shifted in to the IC. After all the data is sent to the HT1611/HT1611C, the \overline{SK} pin is set low to avoid switching to the timer mode.

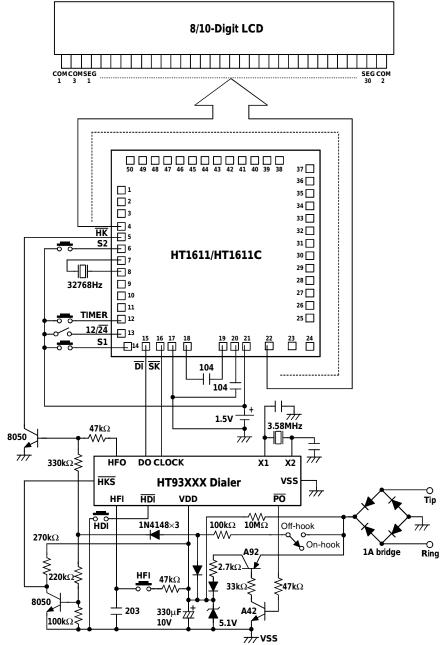
· Data latch timing





Application Circuits

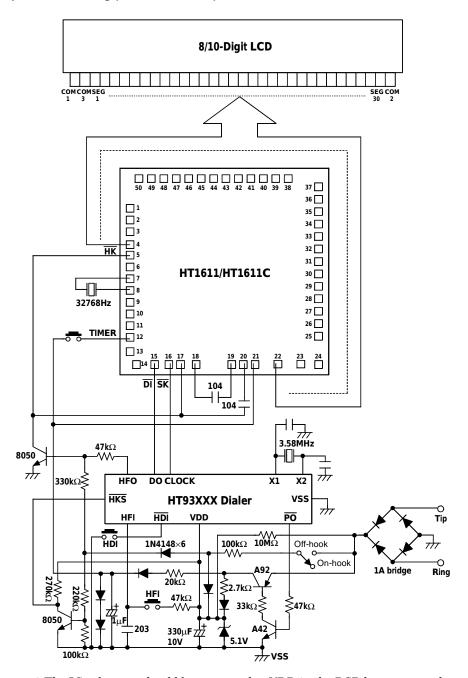
For telephone interfacing (with batteries)



* The IC substrate should be connected to VDD in the PCB layout artwork.



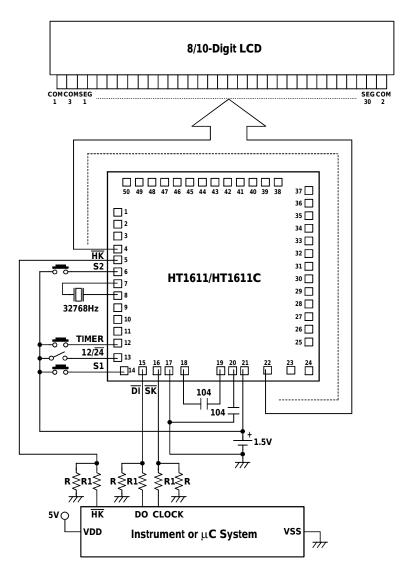
For telephone interfacing (without batteries)



* The IC substrate should be connected to VDD in the PCB layout artwork.



For instrument or μC use



* The IC substrate should be connected to VDD in the PCB layout artwork.

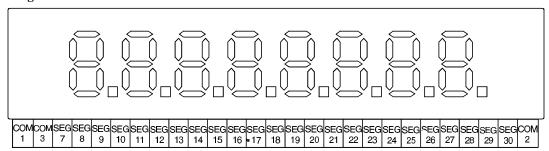
Notes: To drive \overline{SK} , \overline{DI} , \overline{HK} , an open drain NMOS output structure is recommended. To drive \overline{SK} , \overline{DI} and \overline{HK} with a CMOS output structure, a voltage divider is needed (R=4.3k Ω , R1=10k Ω).



LCD Configuration

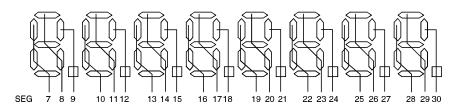
For 8-digit application

• Segment electrode side

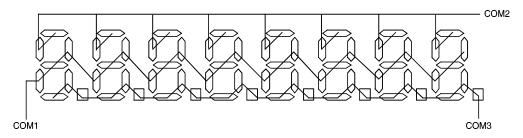


LCD driving system 1/2 bias, 1/3 duty, 3V

• Common electrode side



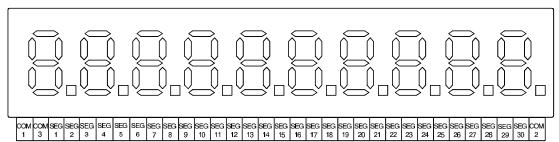
• LCD connection





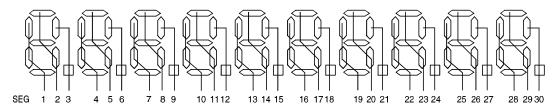
For 10-digit application

• Segment electrode side

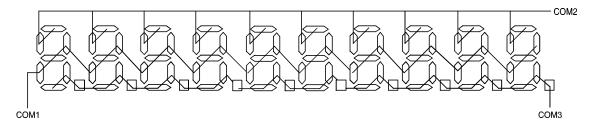


LCD driving system 1/2 bias, 1/3 duty, 3V

• Common electrode side

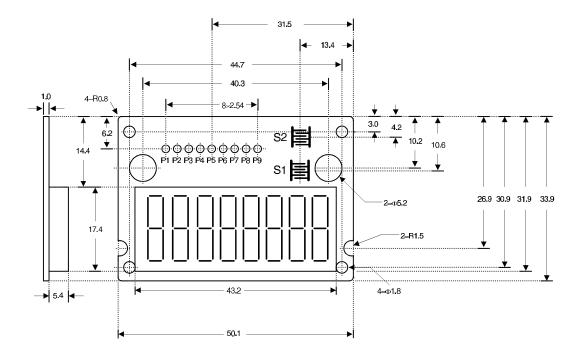


• LCD connection





SW1611M8



P1: 12/24

P1: 12/24
P2: VSS (GND)
P3: SK (CLOCK INPUT)
P4: DI (DATA INPUT)
P5: HK (ON/OFF HOOK)
P6: S2 (ADJ; HMED PECET/PECTARE)

P7: TIMER (TIMER RESET/RESTART)

P8: S1 (SET; MODE SETTING)

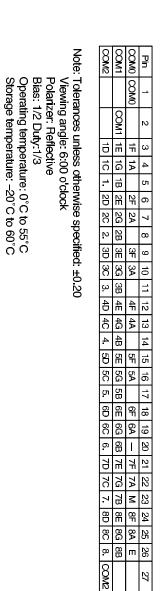
P9: VDD (1.5V)

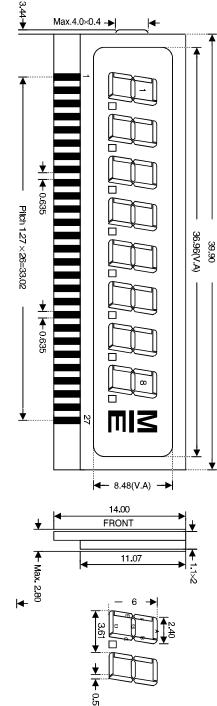
Unit: m/m

Tolerance: $0\sim5m/m$: $\pm0.1m/m$ (Typ.)

5~50m/m: ±0.2m/m (Typ.)

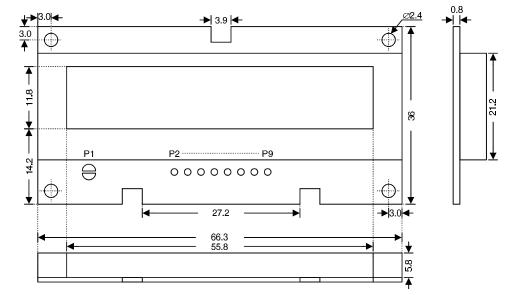








SW1611M10



P1: 12/24 P2: SK (CLOCK INPUT) P3: DI (DATA INPUT) P4: VSS (GND) P5: HK (ON/OFF HOOK)

P6: S2 (ADJ:HOVR/MINUTE ADJUST) P7: TIMER (TIMER RESET/RESTART)

P8: S1 (SET: MODE SETTING)

P9: VDD (1.5V)



Note: Polarizer: Reflective Voltage: 3V, 1/3 duty, 1/2 bias Viewing direction: 6 o'clock Operating temperature: 0°C to 50°C

